

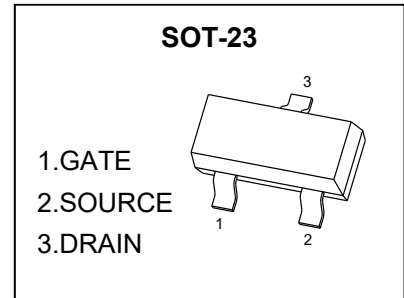


SOT-23 Plastic-Encapsulate MOSFET

CJ8810A N-Channel MOSFET

Key Performance Parameters

V _{BR(DSS)}	R _{DS(on)} TYP	I _D
20V	13.0mΩ@10V	7.2A
	13.6mΩ@4.5V	
	14.0mΩ@3.8V	
	15.6mΩ@2.5V	
	20.3mΩ@1.8V	



DESCRIPTION

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance.

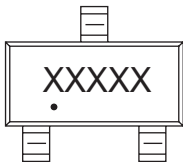
FEATURES

- Battery switch
- Load switch
- High density cell design for ultra low R_{DS(ON)}

APPLICATIONS

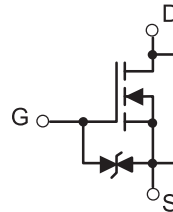
- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

MARKING



XXXXX = 8810A
Solid dot = Green
molding compound device

EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS (T_J=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±10	V
Continuous Drain Current	I _D ^⑤	T _A =25°C	7.2
		T _A =75°C	5.7
Pulsed Drain Current	I _{DM} ^{①②}	30	A
Power Dissipation	P _D ^{①⑤}	1.3	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150	°C

Thermal Characteristics

Parameter	Symbol	Value		Unit	
		Typ	Max		
Thermal Resistance from Junction to Ambient	R _{θJA} ^⑤	t≤10s	63	95	°C/W
		Steady State	90	135	°C/W

Typical Characteristics

ELECTRICAL CHARACTERISTICS (T_J=25°C unless otherwise specified)

Static Characteristics

Parameter	Symbol	Test Condition	Value			Unit	
			Min	Typ	Max		
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	20	-	-	V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =16V, V _{GS} =0V	T _J =25°C	-	-	1.0	μA
			T _J =125°C	-	-	100	
Gate-body leakage current	I _{GSS}	V _{GS} =±4.5V, V _{DS} =0V	-	-	±1	μA	
		V _{GS} =±10V, V _{DS} =0V	-	-	±5	μA	
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.4	0.76	1.0	V	
Static drain-source on-state resistance	R _{DS(on)} ^③	V _{GS} =10V, I _D =7A	T _J =25°C	-	13.0	17.0	mΩ
			T _J =125°C	-	18.0	23.5	
		V _{GS} =4.5V, I _D =6.6A	-	13.6	17.7		
		V _{GS} =3.8V, I _D =6A	-	14.0	19.6		
		V _{GS} =2.5V, I _D =5.5A	-	15.6	22.0		
		V _{GS} =1.8V, I _D =5A	-	20.3	31.0		
Forward transconductance	g _{FS}	V _{DS} =5V, I _D =7A	-	10.5	-	S	

Dynamic Characteristics^④

Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =10V, f=1MHz	-	709	-	pF
Output capacitance	C _{oss}		-	114	-	
Reverse transfer capacitance	C _{rss}		-	85	-	
Total gate charge	Q _g	V _{GS} =4.5V, V _{DS} =10V, I _D =7A	-	7.4	-	nC
Gate charge at threshold	Q _{G(th)}		-	0.6	-	
Gate-source charge	Q _{gs}		-	1.0	-	
Gate-drain charge	Q _{gd}		-	1.8	-	
Turn-on delay time	t _{d(on)}	V _{DD} =10V, V _{GS} =5V, R _L =1.35Ω, R _g =3Ω	-	4.3	-	ns
Turn-on rise time	t _r		-	2.8	-	
Turn-off delay time	t _{d(off)}		-	14.3	-	
Turn-off fall time	t _f		-	2.9	-	

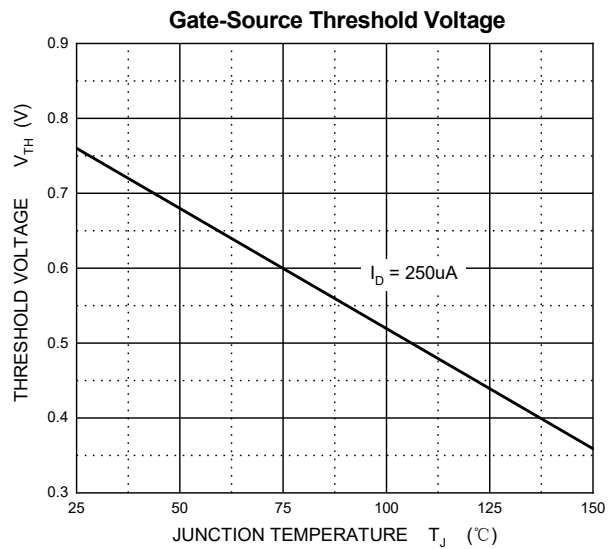
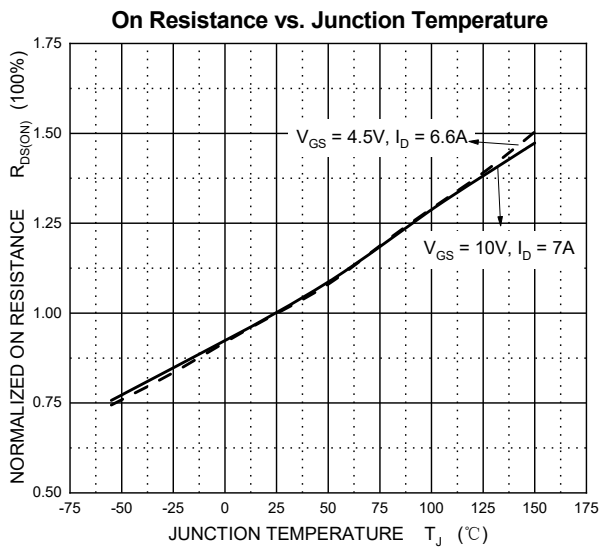
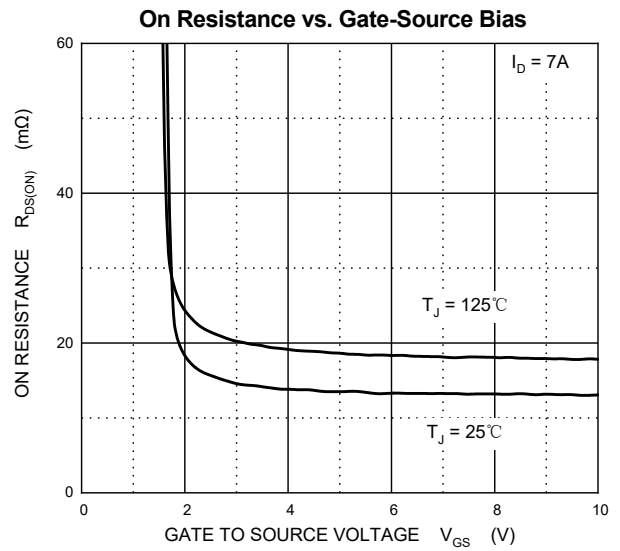
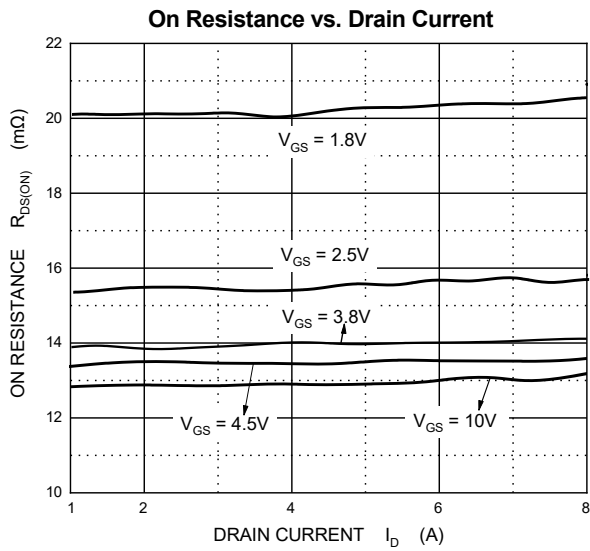
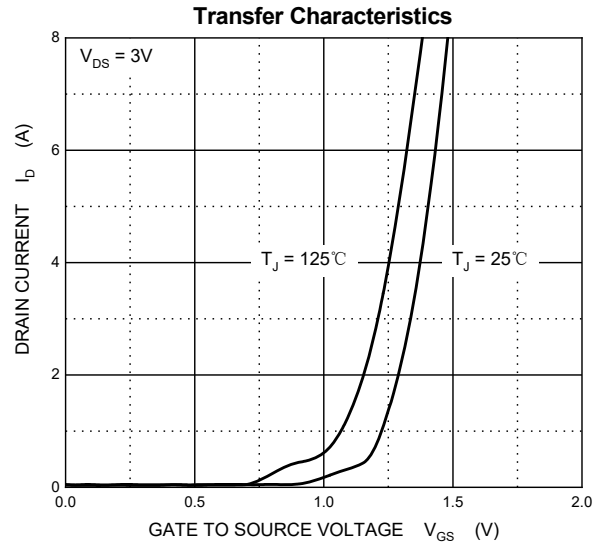
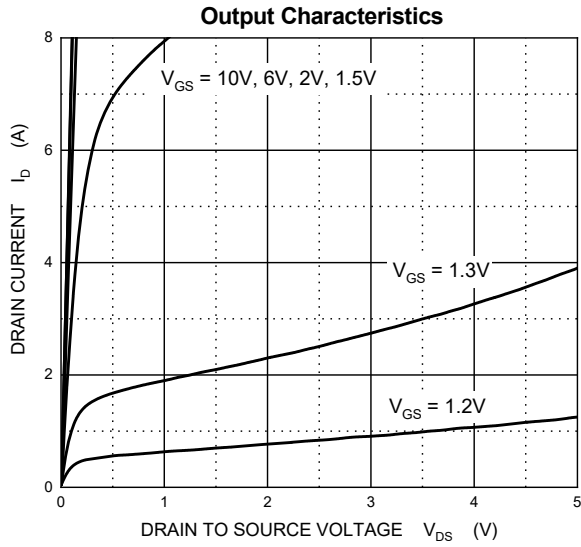
Reverse Diode Characteristics

Drain-source diode forward voltage	V _{SD} ^③	V _{GS} =0V, I _S =1A	-	-	1	V
Continuous drain-source diode forward current	I _S ^①		-	-	7.2	A
Pulsed drain-source diode forward current	I _{SM} ^{①②}		-	-	30	A

Notes:

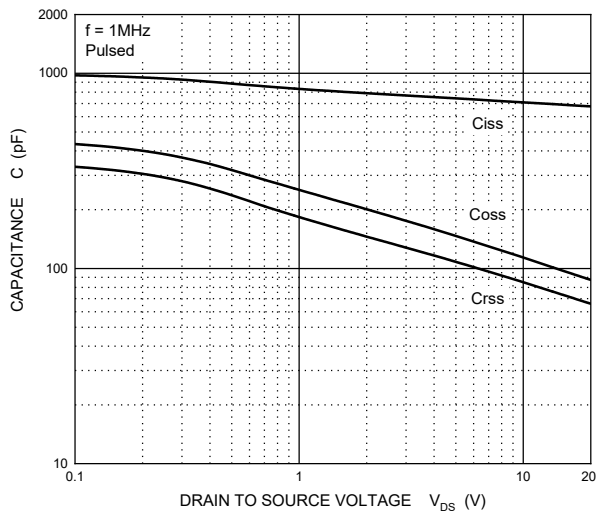
- ①.Limited only by maximum temperature allowed.
- ②.P_w≤10μs, Duty cycle ≤1%.
- ③.Pulse Test : Pulse Width ≤380μs, duty cycle ≤2%.
- ④.Guaranteed by design, not subject to production.
- ⑤.Device mounted on 1 in² FR-4 board with 2oz. double-sided Copper, in a still air environment with T_A=25°C. The current rating is based on the ≤10s thermal resistance rating.

Typical Characteristics

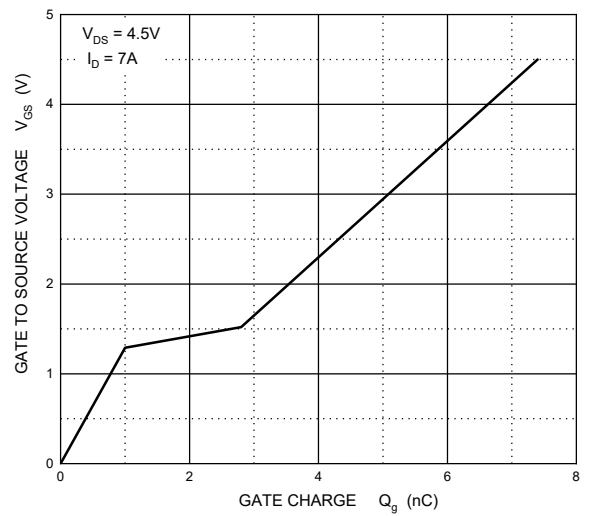


Typical Characteristics

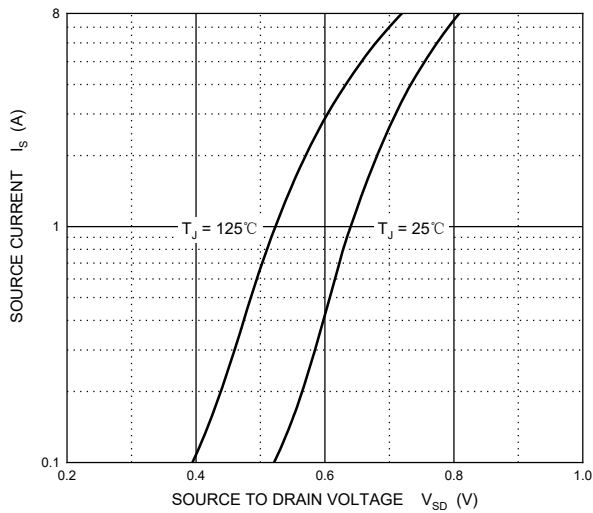
Typical Capacitances



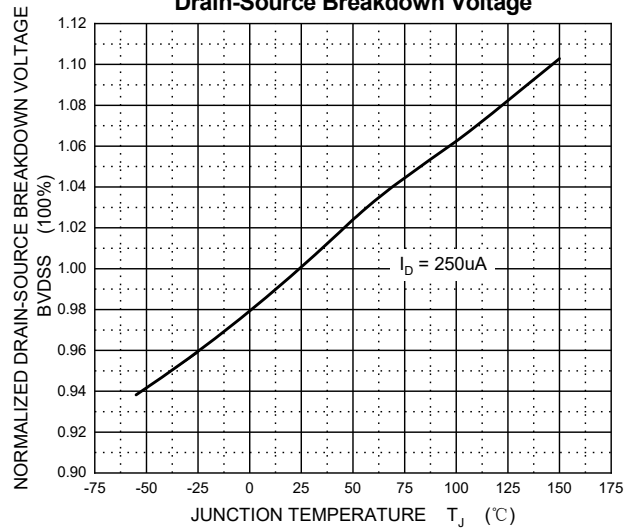
Gate Charge



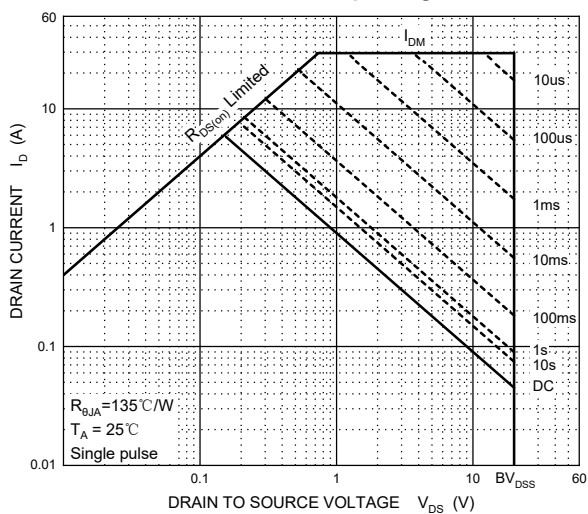
Source-Drain Diode Forward Characteristics



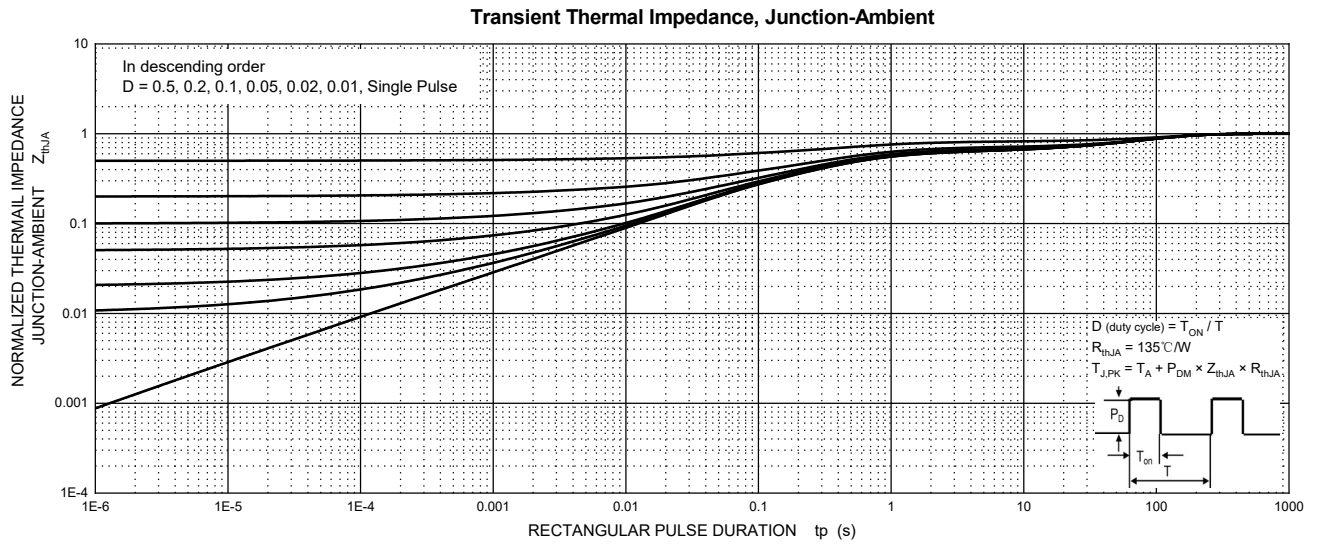
Drain-Source Breakdown Voltage



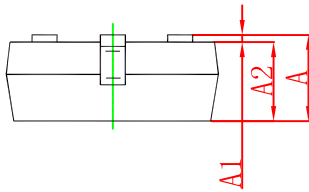
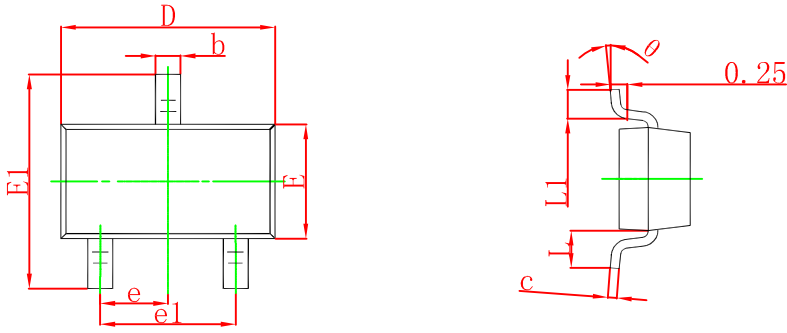
Maximum Safe Operating Area



Typical Characteristics

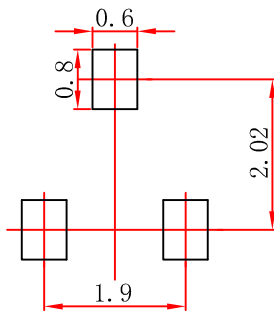


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

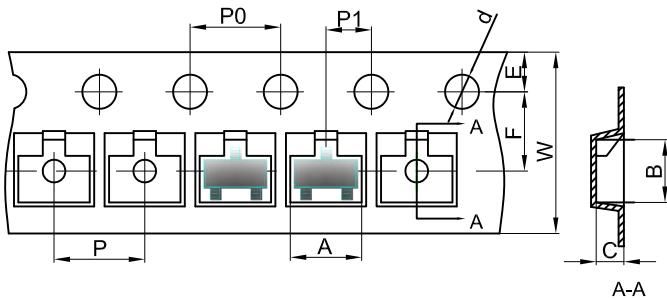
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

NOTICE

JSCJ reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

SOT-23 Tape and Reel

SOT-23 Embossed Carrier Tape



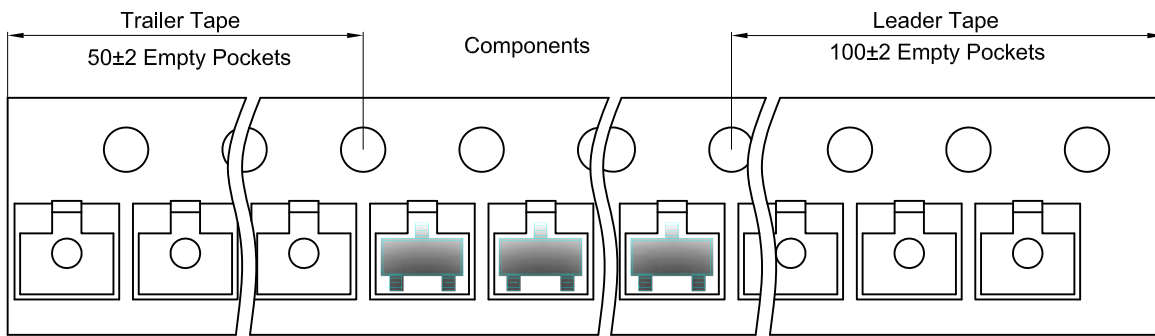
Packaging Description:

SOT-23 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

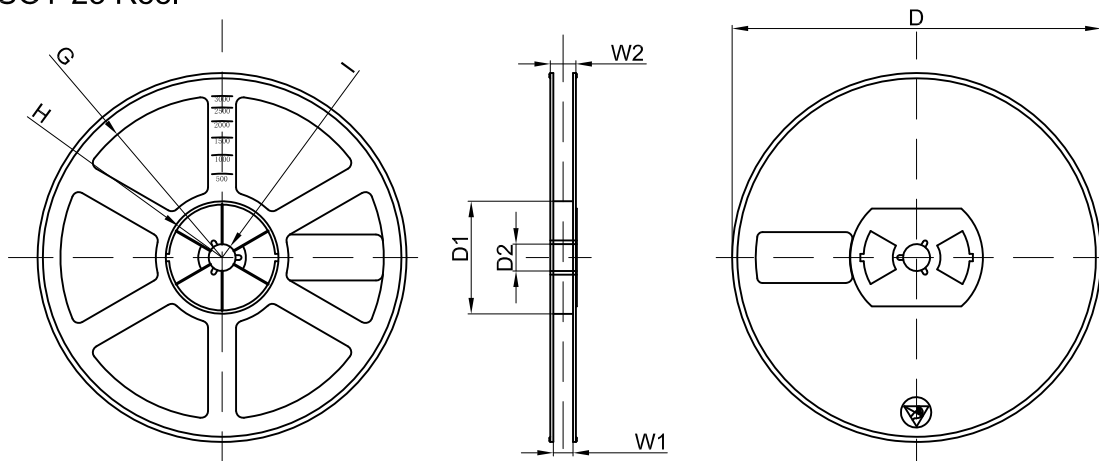
Dimensions are in millimeter

Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

SOT-23 Tape Leader and Trailer



SOT-23 Reel



Dimensions are in millimeter

Reel Option	D	D1	D2	G	H	I	W1	W2
7"Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	45,000 pcs	203×203×195	180,000 pcs	438×438×220	